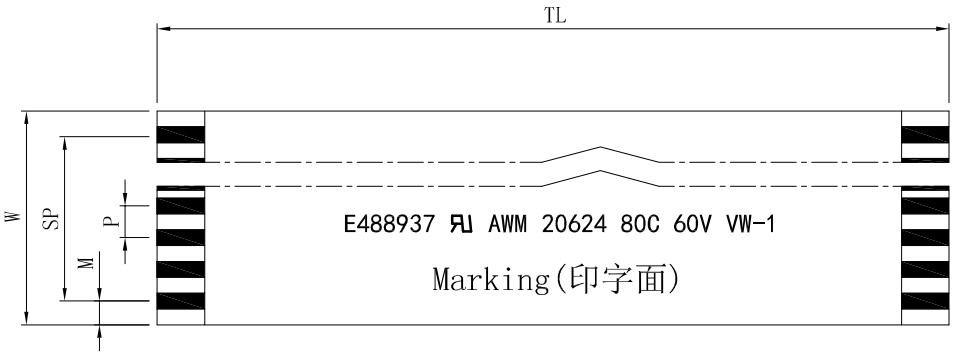
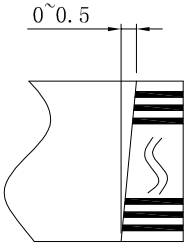
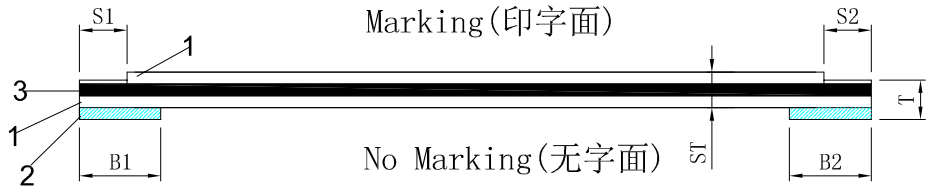
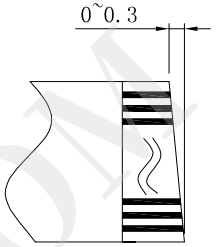
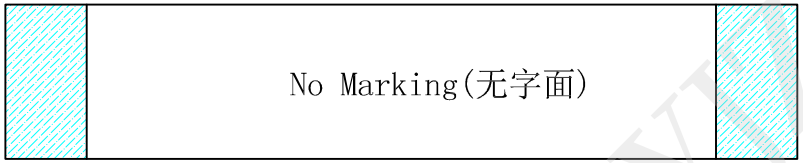



| STRUCTURE(构造) | | | | |
|---|---|---|---|---|
| NO. | ITEM(项目) | SPECIFICATION(规格) | | |
| 1 | INSULATION (胶膜) | 印字: E488937 UL20624(43um) | | |
| | | 白膜: 80℃ 60V(43um) | | |
| 2 | SUPPORTING TAPE (补强板) | 225um | | Blue(蓝色) |
| 3 | CONDUCTOR (导体) | Thickness(厚度) | 0.05 | ±0.005 |
| | | Width(宽度) | 0.65 | ±0.03 |
| | CONDUCTOR (导体镀层) | PLATED(电镀) | 镍Ni(40u") | MIN |
| | | PLATED(电镀) | 金Au(3u") | MIN |

| DIMENSION(尺寸) | | | |
|---|---|---|---|
| No. of conductors (导体数目) | N | 16 | |
| Pitch(间距) | P | 1.0 | ±0.06 |
| Span(总间距) | SP | 15.0 | ±0.1 |
| Width(总宽度) | W | 17.0 | ±0.12 |
| Margin(边缘宽度) | M | 1.0 | ±0.12 |
| Total length(总长度) | TL | 330 | ±3.0 |
| Insert Thickness (插接端厚度) | T | 0.30 | ±0.03 |
| Surface Thickness (线身厚度) | ST | 0.12 | ±0.03 |
| Strip Length (裸铜长度) | S1 | 4.0 | ±1.0 |
| | S2 | 4.0 | ±1.0 |
| Supporting Tape Length(补强板长度) | B1 | 8.0 | ±2.0 |
| | B2 | 8.0 | ±2.0 |

技术要求:

1、保存环境:
温度: 15~25℃ 湿度: 30~50RH%

2、保质期:
镀金: 12个月 镀锡: 6个月

3、产品符合RoHS 2.0标准

深圳市华宇创精密电子有限公司

| | | | |
|---|---|---|---|
| TOLERANCE: X.X ±0.30, X.XX ±0.25, X.XXX ±0.15, X.° ±2°, X.X° ±0.5° | DRAWED BY : 陈一鸣 | DATE : 2014-02-23 | PART NAME: 1.0*16*330*A(4/4/8/8)(0.05*0.65) |
| | CHECKED BY: 马跃 | DATE : 2014-02-23 | PART NO. HYC-FFCX30 |
| | | | MOLD NO. |
| UNIT: mm [inch] | APPROVED BY: 邱敏 | DATE : 2014-02-23 | DRAW NO: HYC-2606241003 |
| SCALE:1:1 SIZE: A4 | | | SHEET NO. 1 OF 1 |

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